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MAS-FIN-128

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By:

Date: DEC 15, 2003

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applic. No. : 10/056,356 Confirmation No. 8042
Applicant : Harry Hedler et al.
Filed : January 24, 2002
TC/A.U. : 2831
Examiner : Hung V. Ngo
Title: : Electronic Component with a Semiconductor
Chip and Method of Producing the Electronic
Component
Docket No. : MAS-FIN-128
Customer No. : 24131

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Hon. Commissioner for Patents
P.O. Box 1450
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RESPONSE under 37 C.F.R. § 1.116

S i r :

In response to the final Office action dated September 15, 2003, please consider the following remarks or arguments:

Remarks/Arguments begin on page 2 of this paper.